

# Microelectronics (ECCDLO5011)

## Sem-V

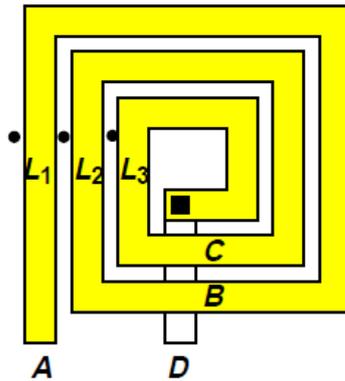
Q1-Q10:1M

Q11-Q15:2M

Q16-Q25:3M

- 1) Photo resist which is initially insoluble and becomes soluble after exposure to UV light is called
  - a) Positive Photoresist
  - b) Negative Photoresist
  - c) Thermo photoresist
  - d) Poly photoresist
- 2) In the mask layout green colour indicates
  - a) p-diffusion
  - b) metal contacts
  - c) polysilicon
  - d) n-diffusion
- 3)  $\lambda$  in MOSFET is
  - a) Body effect coefficient
  - b) channel length modulation coefficient.
  - c) non ideality factor
  - d) fitting parameter
- 4) The equation of current in Linear region for NMOS is
  - a)  $I_{DS} = K_N [(V_{GS} - V_{TN})V_{DS} - V_{DS}^2/2]$
  - b)  $I_{DS} = K_P (V_{GS} - V_{TP})^2$
  - c)  $I_{DS} = K_N (V_{GS} - V_{TN})^2$
  - d)  $I_{DS} = K_N [(V_{GS} - V_{TN})V_{DS}]$
- 5) For the two-transistor current source
  - a)  $I_o = \frac{(W/L)_2}{(W/L)_1} I_{ref}$
  - b)  $I_o = \frac{(W/L)_1}{(W/L)_2} I_{ref}$
  - c)  $I_{ref} = \frac{(W/L)_2}{(W/L)_1} I_o$
  - d)  $I_{ref} = \frac{(W/L)_1}{(W/L)_2} I_o$
- 6) The output voltage of MOS Common Source with Resistive Load amplifier in triode region is
  - a)  $V_o = V_{DD}$
  - b)  $V_o = \frac{R_{ON}}{R_{ON} + R_D} V_{DD}$
  - c)  $V_o = V_{DD} - \frac{k_n}{2} (V_{GS} - V_{TH})^2 R_D$
  - d)  $V_o = \frac{k_n}{2} (V_{GS} - V_{TH})^2 R_D$

7) The overall inductance of the given inductor is



- a)  $L_1+L_2+L_3+M_{12}+M_{23}+M_{13}$
- b)  $M_{12}+M_{23}+M_{13}$
- c)  $L_1+L_2+L_3$
- d)  $M_1+M_2+M_3+L_{12}+L_{23}+L_{13}$

8) Conduction angle for class B power amplifier is

- a)  $\theta=180^\circ$
- b)  $\theta>180^\circ$
- c)  $\theta<180^\circ$
- d)  $0^\circ<\theta<180^\circ$

9) The CMRR for differential amplifier is given as

- a)  $CMRR = \frac{A_d}{A_C}$
- b)  $CMRR = \frac{A_C}{A_d}$
- c)  $CMRR = A_C A_d$
- d)  $CMRR = A_C$

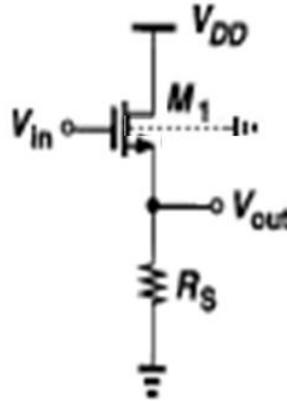
10) In the MOS differential amplifier, the tail acts

- a) Current source
- b) Battery
- c) Transistor
- d) Diode

11) The equation of overdrive voltage in differential amplifier is(2M)

- a)  $\sqrt{I}/kn'(\frac{W}{L})$
- b)  $\sqrt{I}(\frac{W}{L})/kn'$
- c)  $Kn\sqrt{I}(\frac{W}{L})$
- d)  $Kn\sqrt{I}/(\frac{W}{L})$

12) For the given circuit the intrinsic gain is (2m)



- a)  $A_O = \frac{g_m}{(g_m + g_{mb})}$
- b)  $A_O = \frac{(g_m + g_{mb})}{(g_m)}$
- c)  $A_O = \frac{1}{\frac{1}{r_o} + g_m + g_{mb}}$
- d)  $A_O = \frac{1}{\frac{1}{r_o}(g_m + g_{mb})}$

13) The total capacitance between gate and source of MOS in saturation is given as(2M)

- a)  $C_{gs(T)} = \frac{1}{2}C_{ox}WL + C_{GS(overlap)}$
- b)  $C_{gs(T)} = \frac{2}{3}C_{ox}WL + C_{GS(overlap)}$
- c)  $C_{gs(T)} = C_{GS(overlap)}$
- d)  $C_{gs(T)} = 0.5C_{ox}WL$

14) For active load MOS differential amplifier, the differential gain is given as (2M)

- a)  $A_d = 2\sqrt{\frac{2K_n}{I_Q}} \frac{1}{\lambda_2 + \lambda_4}$
- b)  $A_d = \sqrt{\frac{4K_n}{I_Q}} \frac{1}{\lambda_2 + \lambda_4}$
- c)  $A_d = 2\sqrt{\frac{K_n}{I_Q}} \frac{1}{\lambda_2 + \lambda_4}$
- d)  $A_d = 2\sqrt{\frac{3K_n}{I_Q}} \frac{1}{\lambda_2 + \lambda_4}$

15) The problem of stacking caused by MOS active load in amplifiers can be avoided by(2M)

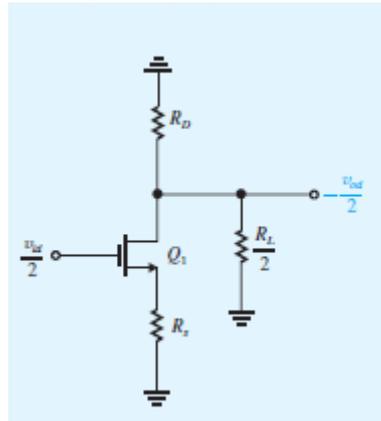
- a) Cascoded amplifiers
- b) Double cascoded
- c) Folded cascode
- d) Cascade amplifiers

16) Various measurements are made on an NMOS amplifier for which the drain resistor  $R_D$  is 20 k $\Omega$ . First, DC measurements show the voltage across the drain resistor,  $V_{RD}$ , to be 2 V and the

gate-to-source bias voltage to be 1.2 V. Then, ac measurements with small signals show the voltage gain to be  $-10$  V/V. If the process transconductance parameter is  $50\mu\text{A}/\text{V}^2$ , what is the MOSFET's  $W/L$ ? (3M)

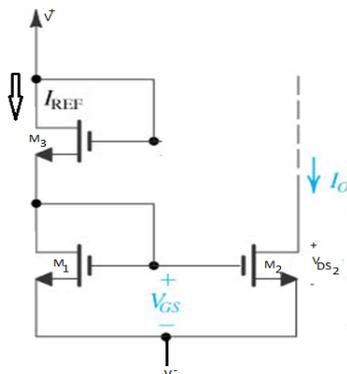
- a) 25
- b) 50
- c) 75
- d) 100

17) For the given circuit, the differential gain is (3M)



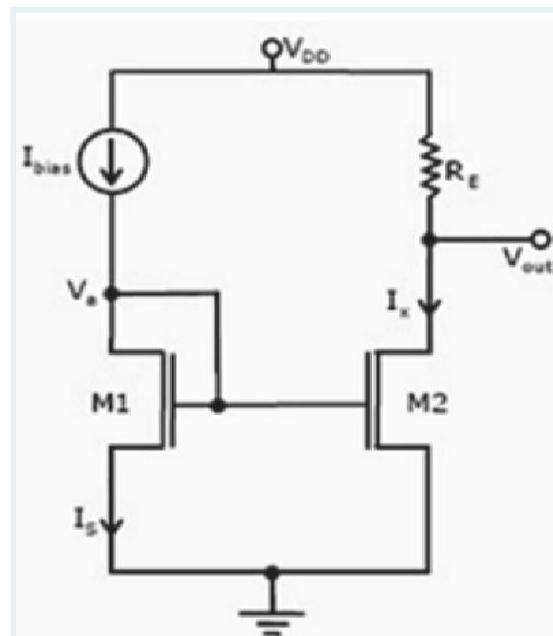
- a)  $A_d = \frac{R_{D//(\frac{R_L}{2})}}{\frac{1}{g_m} + R_S}$
- b)  $A_d = \frac{R_{D//(\frac{R_L}{2})}}{\frac{1}{g_m}}$
- c)  $A_d = \frac{R_{D//(\frac{R_L}{2})}}{R_S}$
- d)  $A_d = R_{D//(\frac{R_L}{2})}$

18) For the three transistor MOSFET current source having  $V^+=10\text{V}$  and  $V^-=2\text{V}$ . The transistor parameters are  $K_n=40\mu\text{A}/\text{V}^2$ ,  $V_{TH}=1\text{V}$  and  $\lambda=0$ . The  $(W/L)_2$  of  $M_2$  is Given that  $I_{REF}=0.25\text{mA}$ ,  $I_o=0.1\text{mA}$  and  $V_{DS2}=0.85\text{V}$ . (3M)



- a) 3.46
- b) 0.235
- c) 8.65
- d) 4.25

- 19) Compare the output resistance of cascode MOSFET current source to two transistor current source. Assume  $I_{ref}=I_0=100\mu A$  in both the circuits,  $\lambda=0.01V^{-1}$  for the transistors and  $g_m=0.5mA/V$ .(3M)
- 10times more
  - 5 times more
  - 20 times more
  - 500 times more
- 20) When the gate – to – source voltage ( $V_{GS}$ ) of a MOSFET with threshold voltage of 400 mV, working in saturation is 900 mV, the drain current is observed to be 1 mA. Neglecting the channel width modulation effect and assuming that the MOSFET is operating at saturation, the drain current for an applied  $V_{GS}$  of 1400mV is (3M)
- 0.5 mA
  - 4.0 mA
  - 2.0 mA
  - 3.5 mA
- 21) Consider the basic two transistor NMOS current source. the circuit parameters are  $V_{DD}=5V$ ,  $V_{SS}=-5V$  and  $I_{ref}=0.250mA$ . The transistors parameters are  $\lambda=0.02V^{-1}$ ,  $V_{TN}=1V$ ,  $K_n'=00.8mA/V^2$ , If  $W/L=3$  find  $I_0$  for  $V_{DS2}=3V$ . Give your answer in micro amperes.(3M)
- 230
  - 252.8
  - 264
  - 224
- 22) For the circuit shown in fig transistors M1 and M2 are identical NMOS transistors. Assume that M2 is in saturation and the output is unloaded. The  $I_x$  is related to  $I_{bias}$



as(3M)

- $I_x=I_S-I_{bias}$
- $I_x=I_{bias}$
- $I_x=I_S+I_{bias}$
- $I_x=I_{bias}-(V_{DD}-V_{out}/R_E)$

